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			ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/735,989	12/15/2003	Somenath Mitra	436/12	4147
27538	7590 11/17/2006	EXAMINER		
	ILMAN GIBSON & I	ROBINSON, DANIEL LEON		
900 ROUTE 9 NORTH WOODBRIDGE, NJ 07095			ART UNIT	PAPER NUMBER
	,		3742	

DATE MAILED: 11/17/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)		
Office Action Commons	10/735,989	MITRA ET AL.		
Office Action Summary	Examiner	Art Unit		
	Daniel L. Robinson	3742		
The MAILING DATE of this communication app Period for Reply	pears on the cover sheet with the	correspondence address		
A SHORTENED STATUTORY PERIOD FOR REPL WHICHEVER IS LONGER, FROM THE MAILING D. - Extensions of time may be available under the provisions of 37 CFR 1.1 after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period - Failure to reply within the set or extended period for reply will, by statute Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATIO 36(a). In no event, however, may a reply be tin will apply and will expire SIX (6) MONTHS from e, cause the application to become ABANDONE	N. mely filed the mailing date of this communication. ED (35 U.S.C. § 133).		
Status	•			
1) Responsive to communication(s) filed on <u>8-16</u>	<u>-20006</u> .			
a) ☐ This action is FINAL . 2b) ☑ This action is non-final.				
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is				
closed in accordance with the practice under E	Ex parte Quayle, 1935 C.D. 11, 4	53 O.G. 213.		
Disposition of Claims				
4) Claim(s) 1-20 is/are pending in the application 4a) Of the above claim(s) is/are withdray 5) Claim(s) is/are allowed. 6) Claim(s) 1-20 is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and/o	wn from consideration.			
Application Papers				
9) The specification is objected to by the Examine 10) The drawing(s) filed on is/are: a) acc Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the Ex	epted or b) objected to by the drawing(s) be held in abeyance. Se tion is required if the drawing(s) is ob	e 37 CFR 1.85(a). _. ejected to. See 37 CFR 1.121(d).		
Priority under 35 U.S.C. § 119				
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority document 2. Certified copies of the priority document 3. Copies of the certified copies of the priority application from the International Bureau * See the attached detailed Office action for a list	s have been received. s have been received in Applicat rity documents have been receiv u (PCT Rule 17.2(a)).	ion No ed in this National Stage		
Attachment(s)	_			
Notice of References Cited (PTO-892) Notice of Draftsperson's Patent Drawing Review (PTO-948) Information Disclosure Statement(s) (PTO/SB/08) Paper No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail D 5) Notice of Informal F 6) Other:	ate		

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DETAILED ACTION

Claim Rejections - 35 USC § 102

form the basis for the rejections under this section made in this Office action:

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A person shall be entitled to a patent unless -

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The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that

(e) the invention was described in (1) an application for patent, published under section 122(b), by

another filed in the United States before the invention by the applicant for patent or (2) a patent

granted on an application for patent by another filed in the United States before the invention by the

applicant for patent, except that an international application filed under the treaty defined in section

351(a) shall have the effects for purposes of this subsection of an application filed in the United States

only if the international application designated the United States and was published under Article 21 (2)

of such treaty in the English language.

2. Claims 1-2, 5 and 10-11 are rejected under 35 U.S.C. 102(b) as being

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anticipated by Manginell et al (6,527,835).

Manginell teaches a microheater for microanalytical system comprising a microchannel

16 formed on a silicon substrate-wafer 11 and having a length, and a conductor 13 formed in the microchannel 16, the conductor is formed from platinum metal (col.

3,

lines 20-67) and disposed along a majority of the length of the channel 16.

Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
- (a) A patent may not be obtained though the invention is not identically disclosed or described as set

forth in section 102 of this title, if the differences between the subject matter sought to be patented and

the prior art are such that the subject matter as a whole would have been obvious at the time the

invention was made to a person having ordinary skill in the art to which said subject matter pertains.

Patentability shall not be negatived by the manner in which the invention was made.

4. Claims 6-7, 9 and 12-13 are rejected under 35 U.S.C. 103(a) as being unpatentable over Manginell in view of Ferguson (2003/0209534).

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Manginell discloses substantially the claimed invention, but does not disclose quartz

and borosilicate glass. Ferguson discloses resistive heating systems with a substrate

202 comprising quartz and borosilicate glass (page 10, [0068]). It would have been

obvious to one having ordinary skill in the art to modify Manginelrs invention to include

the substrate comprising quartz and borosilicate glass as taught by Ferguson in order to

provide a more rigid structure for the microheater.

As for claims 9 and 13, it would have been obvious to include a glass-insulating layer

disposed on the conductor 13 because it is conventional to insulate the heaterconductor to avoid short circuitry.

5. Claims 14-15 and 18-20 are rejected under 35 U.S.C. 103(a) as being unpatentable over Manginell in view of Lin (5,855,801).

Manginell discloses substantially the claimed invention, but does not disclose a method

of fabricating including patterning and etching the substrate.

Lin discloses a method of fabricating a microstructure of a microheater comprising

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microchannel 78 formed on a silicon substrate-wafer 46 including patterning and etching

of the substrate 46 (col. 4, lines 21-67, col. 10, line 53-67) and etching of the substrate

46 with a boron-doped region 52 (col. 4, lines 6-67).

It would have been obvious to one having ordinary skill in the art to modify Manginell's

invention to use a method of fabricating a microstructure including patterning and etching the substrate as taught by Lin as one of the conventional methods of fabricating

a microstructure of the microheater (col. 4, lines 40-45).

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etching the substrate as taught by Lin as one of the conventional methods of fabricating

a microstructure of the microheater (col. 4, lines 40-45).

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6. Claim 3 is rejected under 35 U.S.C. 103(a) as being unpatentable over Manginell

in view of Kenny (6,551,849).

Manginell discloses substantially the claimed invention, but does not disclose the conductor comprising aluminum alloy and silicon.

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Kenny discloses a method of fabricating arrays of microneedles-microchannels comprising electrically conductive pads 250 comprising aluminum, copper and polysilicon (col. 3, lines 15-25, col. 9, lines 15-25).

The limitation of the conductor comprising an aluminum alloy with 99% aluminum and

silicon and copper, it is deemed that the material used for conductor would be chosen

by the user in order to assure a good conductivity. Therefore it would have been obvious to make the conductor of Manginell out of 99% aluminum, silicon and copper as

taught by Kenny in order to obtain the good conductivity of the microheater (col. 3, lines

15-25, col. 9, lines 15-25).

7. Claims 4 and 8 are rejected under 35 U.S.C. 103(a) as being unpatentable over

Manginell in view of Yamazaki et al (6,165,876) and further in view Ueno et al (2002/00224662).

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Manginell discloses substantially the claimed invention, but does not disclose a substrate comprising a polished silicon wafer, and the conductor-heater comprising

boron ions. Yamazaki discloses a method of doping a silicon film 203 with boron ion

(col. 15, lines 1-18). Ueno discloses a microfluidic device having a heater 3 with a mirror- polished substrate (page 5, [0094]). It would have been obvious to one having

ordinary skill in the art to modify Manginelrs invention to include a doped substrate with

boron ions as taught by Yamazaki and a polished substrate as taught by Ueno and a

conductor comprising boron ions as taught by Yamazaki in order to improve crystallinity

of the film heater-microheater (Abstract)

8. Claims 16-17 are rejected under 35 U.S.C. 103(a) as being unpatentable over Manginell in view of Lin and further in view of Yamazaki.

Manginell in view of Lin discloses substantially the claimed invention, but do not teach

boron ion implantation. Yamazaki teaches a method of implanting boron (col. 15, lines

1-10). It would have been obvious 10 one having ordinary skill in the art to modify the

invention of Manginell in view of Lin to include a boron ion implantation as taught by

Yamazaki in a method for fabricating a microheater of Manginell in view of Lin in order

to improve crystallinity of the film heater-microheater (Abstract).

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Daniel L. Robinson whose telephone number is 571-272-4788. The examiner can normally be reached on m-f 5:30-2:30.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Robin Evans can be reached on 571-272-4777. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

DANIEL ROBINSON PRIMARY EXAMINER Art Unit: 3742

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

dlr